

DESCRIPTION

The ISP817, ISP827 and ISP847 series of optically coupled isolator consist of an infrared light emitting diode and an NPN silicon photo transistor in a space efficient Dual In Line Plastic Package.

FEATURES

- AC Isolation Voltage 5300V_{RMS}
- CTR Selections Available
- Wide Operating Temperature Range
 -55°C to +110°C ISP817
 -30°C to +100°C ISP827 / ISP847
- Lead Free and RoHS Compliant
- UL File E91231 Package Code "EE"
- VDE Approval Certificate No. 40028086

APPLICATIONS

- Computer Terminals
- Industrial System Controllers
- Measuring Instruments
- Signal Transmission between Systems of Different Potentials and Impedances

ORDER INFORMATION

- Add X after PN for VDE Approval
- Add G after PN for 10mm lead spacing
- Add SM after PN for Surface Mount
- Add SMT&R after PN for Surface Mount Tape & Reel (Available for ISP817SM and ISP827SM)
- Consult Factory for Tape and Reel version of ISP847SM

ROHS (

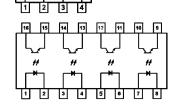
ISP817



8 7 6 5

ISP847

ISP827



ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device.

Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

Input

Forward Current 50mA Peak Forward Current (100 μ s, 100Hz) 1A Reverse Voltage 6V Power dissipation 70mW

Output

Collector to Emitter Voltage V_{CEO}

ISP817 80V

ISP827 / ISP847 35V

Emitter to Collector Voltage V_{ECO} 6V Collector Current 50mA

Power Dissipation 150mW

Total Package

ISP827 / ISP847 -30 to 100 °C

Junction Temperature 125 °C

Storage Temperature -55 to 125 °C

Lead Soldering Temperature (10s) 260°C

ISOCOM COMPONENTS 2004 LTD

Unit 25B, Park View Road West, Park View Industrial Estate Hartlepool, Cleveland, TS25 1PE, United Kingdom Tel: +44 (0)1429 863 609 Fax: +44 (0)1429 863 581 e-mail: sales@isocom.co.uk http://www.isocom.com

ISOCOM COMPONENTS ASIA LTD

Hong Kong Office
Block A, 8/F, Wah Hing Industrial Mansion
36 Tai Yau Street, San Po Kong, Kowloon, Hong Kong
Tel: +852 2995 9217 Fax: +852 8161 6292
e-mail: sales@isocom.com.hk



ELECTRICAL CHARACTERISTICS (Ambient Temperature = 25°C unless otherwise specified)

INPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward Voltage	V_{F}	$I_F = 20 \text{mA}$		1.2	1.4	V
Reverse Leakage	I_R	$V_R = 4V$			10	μΑ
Terminal Capacitance	C_{t}	V = 0V, $f = 1KHz$		30	250	pF

OUTPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector-Emitter	BV_{CEO}	$I_C = 0.1 \text{mA}, I_F = 0 \text{mA}$				V
Breakdown Voltage		ISP817	80			
		ISP827 / ISP847	35			
Emitter-Collector Breakdown Voltage	BV _{ECO}	$I_E=10\mu A,I_F=0mA$	6			V
Collector-Emitter Dark Current	I_{CEO}	$V_{CE} = 20V$, $I_F = 0mA$			100	nA



ELECTRICAL CHARACTERISTICS (Ambient Temperature = 25°C unless otherwise specified)

COUPLED

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Current Transfer Ratio	CTR	I_F = 5mA, V_{CE} = 5V Optional CTR Grades GB BL	50 100 200		600 600 600	%
		GR A B C D	100 80 130 200 300		300 160 260 400 600	
Collector–Emitter Saturation Voltage	V _{CE(sat)}	$I_F = 20 \text{mA}, I_C = 1 \text{mA}$		0.1	0.2	V
Floating Capacitance	C_{f}	V = 0V, $f = 1MHz$		0.6	1	pF
Cut-Off Frequency	fc	$V_{CE} = 5V, I_{C} = 2mA,$ $R_{L} = 100\Omega,$ -3dB		80		kHz
Output Rise Time	$t_{\rm r}$	$V_{CE} = 2V$, Ic = 2mA,		4	18	μs
Output Fall Time	t_{f}	$R_L = 100\Omega$		3	18	

ISOLATION

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Input to Output Isolation Voltage	$V_{\rm ISO}$	AC 1 minute, RH = 40% to 60% Note 1	5300			V_{RMS}
Input to Output Isolation Resistance	$R_{\rm ISO}$	V_{IO} = 500V, RH = 40% to 60% Note 1	5x10 ¹⁰	1x10 ¹¹		Ω

Note 1: Measure with input leads shorted together and output leads shorted together.



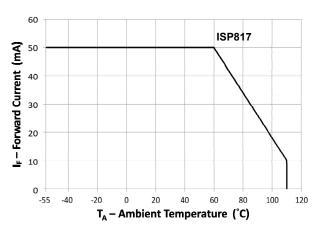


Fig 1 Forward Current vs Ambient Temperature (1)

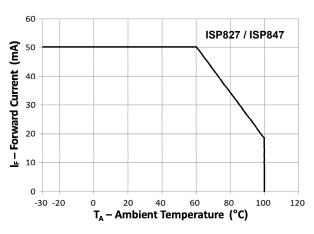


Fig 3 Forward Current vs Ambient Temperature (2)

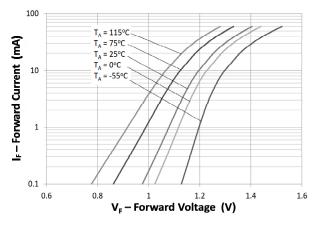


Fig 5 Forward Current vs Forward Voltage

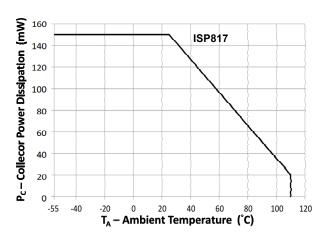


Fig 2 Collector Power Dissipation vs Ambient Temperature (1)

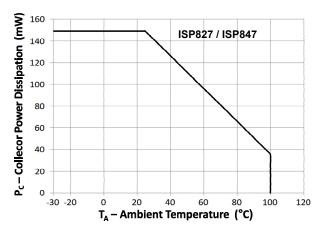


Fig 4 Collector Power Dissipation vs Ambient Temperature (2)

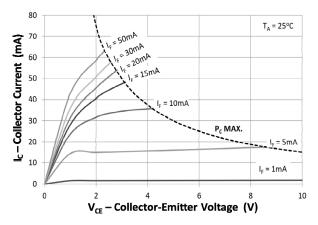


Fig 6 Collector Current vs Collector-Emitter Voltage



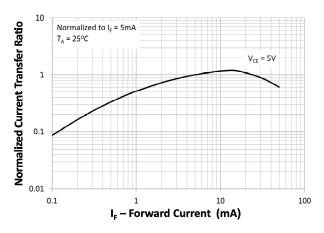


Fig 7 Normalized Current Transfer Ratio vs Forward Current

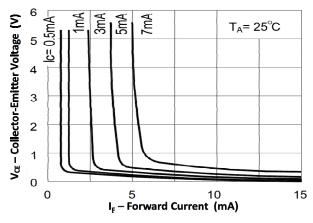


Fig 9 Collector-Emitter Voltage vs Forward Current

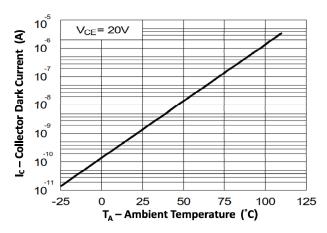


Fig 11 Collector Dark Current vs Ambient Temperature

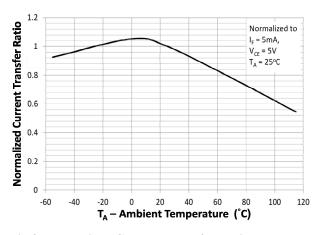


Fig 8 Normalized Current Transfer Ratio vs Ambient Temperature

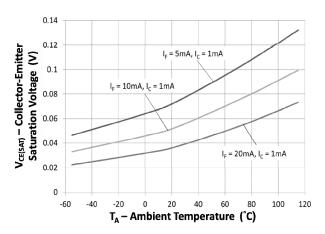


Fig 10 Collector-Emitter Saturation Voltage vs Ambient Temperature



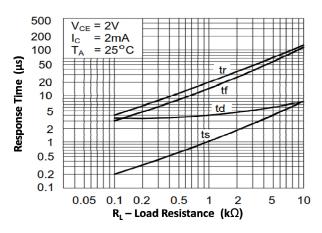
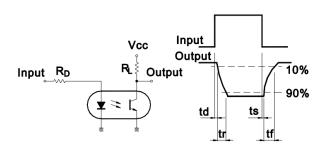


Fig 12 Response Time vs Load Resistance



Response Time Test Circuit

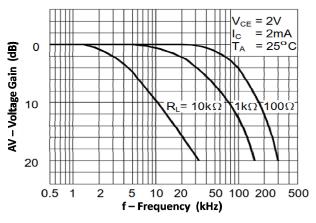
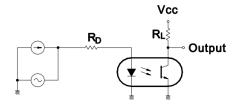


Fig 13 Frequency Response



Frequency Response Test Circuit



ORDER INFORMATION

	ISP817 (UL Approval)					
After PN	PN	Description	Packing quantity			
None	ISP817, ISP817GB, ISP817BL, ISP817GR, ISP817A, ISP817B, ISP817C, ISP817D	Standard DIP4	100 pcs per tube			
G	ISP817G, ISP817GBG, ISP817BLG, ISP817GRG, ISP817AG, ISP817BG, ISP817CG, ISP817DG	10mm Lead Spacing	100 pcs per tube			
SM	ISP817SM, ISP817GBSM, ISP817BLSM, ISP817GRSM, ISP817ASM, ISP817BSM, ISP817CSM, ISP817DSM	Surface Mount	100 pcs per tube			
SMT&R	ISP817SMT&R, ISP817GBSMT&R, ISP817GRSMT&R, ISP817BLSMT&R, ISP817ASMT&R, ISP817BSMT&R, ISP817CSMT&R, ISP817DSMT&R	Surface Mount Tape & Reel	1000 pcs per reel			

	ISP827 (UL Approval)					
After PN	PN	Description	Packing quantity			
None	ISP827, ISP827GB, ISP827BL, ISP827GR, ISP827A, ISP827B, ISP827C, ISP827D	Standard DIP8	50 pcs per tube			
G	ISP827G, ISP827GBG, ISP827BLG, ISP827GRG, ISP827AG, ISP827BG, ISP827CG, ISP827DG	10mm Lead Spacing	50 pcs per tube			
SM	ISP827SM, ISP827GBSM, ISP827BLSM, ISP827GRSM, ISP827ASM, ISP827BSM, ISP827CSM, ISP827DSM	Surface Mount	50 pcs per tube			
SMT&R	ISP827SMT&R, ISP827GBSMT&R, ISP827GRSMT&R, ISP827BLSMT&R, ISP827ASMT&R, ISP827BSMT&R, ISP827CSMT&R, ISP827CSMT&R	Surface Mount Tape & Reel	1000 pcs per reel			

	ISP847 (UL Approval)					
After PN	PN	Description	Packing quantity			
None	ISP847, ISP847GB, ISP847BL, ISP847GR, ISP847A, ISP847B, ISP847C, ISP847D	Standard DIP16	25 pcs per tube			
G	ISP847G, ISP847GBG, ISP847BLG, ISP847GRG, ISP847AG, ISP847BG, ISP847CG, ISP847DG	10mm Lead Spacing	25 pcs per tube			
SM	ISP847SM, ISP847GBSM, ISP847BLSM, ISP847GRSM, ISP847ASM, ISP847BSM, ISP847CSM, ISP847DSM	Surface Mount	25 pcs per tube			



ORDER INFORMATION

	ISP817X (UL and VDE Approvals)					
After PN	PN	Description	Packing quantity			
None	ISP817X, ISP817XGB, ISP817XBL, ISP817XGR, ISP817XA, ISP817XB, ISP817XC, ISP817XD	Standard DIP4	100 pcs per tube			
G	ISP817XG, ISP817XGBG, ISP817XBLG, ISP817XGRG, ISP817XAG, ISP817XBG, ISP817XCG, ISP817XDG	10mm Lead Spacing	100 pcs per tube			
SM	ISP817XSM, ISP817XGBSM, ISP817XGRSM, ISP817XBLSM, ISP817XASM, ISP817XBXSM, ISP817XCSM, ISP817XDSM	Surface Mount	100 pcs per tube			
SMT&R	ISP817XSMT&R, ISP817XGBSMT&R, ISP817XGRSMT&R, ISP817XBLSMT&R, ISP817XASMT&R, ISP817XDSMT&R, ISP817XCSMT&R, ISP817XDSMT&R	Surface Mount Tape & Reel	1000 pcs per reel			

	ISP827X (UL and VDE Approvals)					
After PN	PN	Description	Packing quantity			
None	ISP827X, ISP827XGB, ISP827XBL, ISP827XGR, ISP827XA, ISP827XB, ISP827XC, ISP827XD	Standard DIP8	50 pcs per tube			
G	ISP827XG, ISP827XGBG, ISP827XBLG, ISP827XGRG, ISP827XAG, ISP827XBG, ISP827XCG, ISP827XDG	10mm Lead Spacing	50 pcs per tube			
SM	ISP827XSM, ISP827XGBSM, ISP827XGRSM, ISP827XBLSM, ISP827XASM, ISP827XBSM, ISP827XCSM, ISP827XDSM	Surface Mount	50 pcs per tube			
SMT&R	ISP827XSMT&R, ISP827XGBSMT&R, ISP827XGRSMT&R, ISP827XBLSMT&R, ISP827XASMT&R, ISP827XDSMT&R, ISP827XCSMT&R, ISP827XDSMT&R	Surface Mount Tape & Reel	1000 pcs per reel			

	ISP847 (UL and VDE Approvals)					
After PN	PN	Description	Packing quantity			
None	ISP847X, ISP847XGBL, ISP847XBL, ISP847XGR, ISP847XA, ISP847XB, ISP847XC, ISP847XD	Standard DIP16	25 pcs per tube			
G	ISP847XG, ISP847XGBG, ISP847XBLG, ISP847XGRG, ISP847XAG, ISP847XBG, ISP847XCG, ISP847XDG	10mm Lead Spacing	25 pcs per tube			
SM	ISP847XSM, ISP847XGBSM, ISP847XGRSM, ISP847XBLSM, ISP847XASM, ISP847XBSM, ISP847XCSM, ISP847XDSM	Surface Mount	25 pcs per tube			

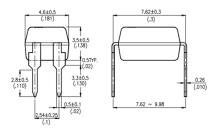


PACKAGE DIMENSIONS in mm (inch)

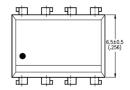
DIP

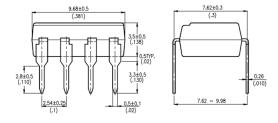




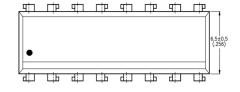


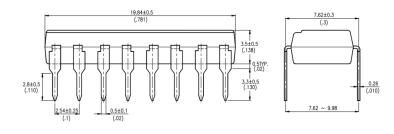
ISP827





ISP847



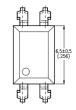


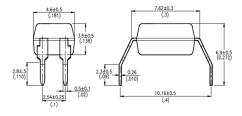


PACKAGE DIMENSIONS in mm (inch)

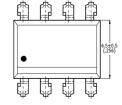
G Form

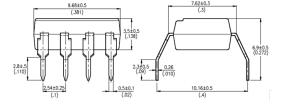
ISP817G



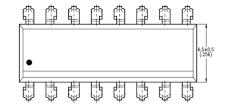


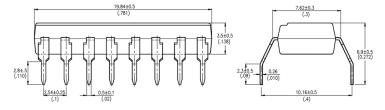
ISP827G





ISP847G



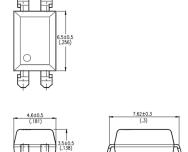




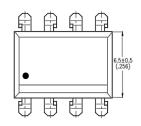
PACKAGE DIMENSIONS in mm (inch)

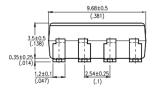
SMD

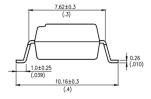
ISP817SM



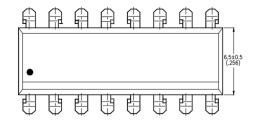
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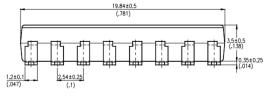


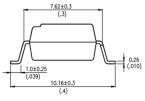




ISP847SM



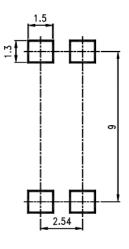




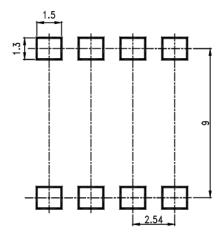


RECOMMENDED PAD LAYOUT FOR SMD (mm)

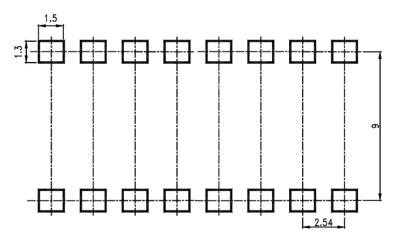




ISP827SM



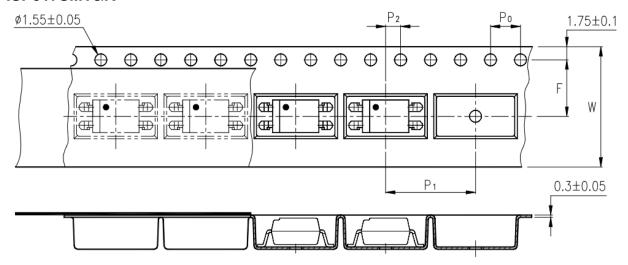
ISP847SM



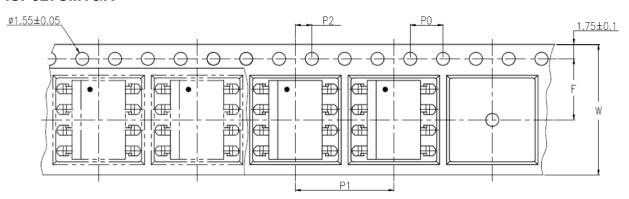


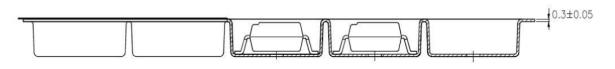
TAPE AND REEL PACKAGING

ISP817SMT&R



ISP827SMT&R

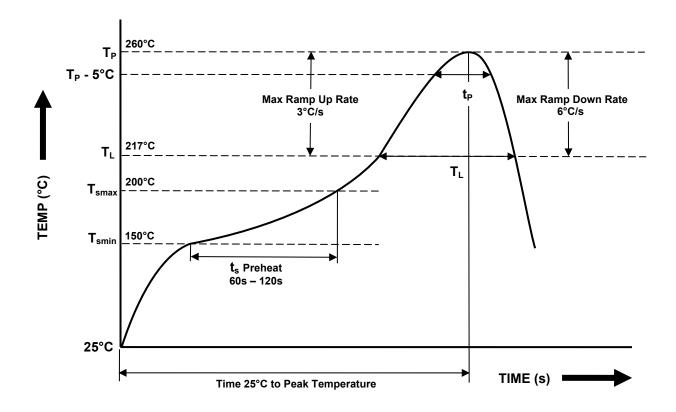




Description	Symbol	Dimension mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	P ₀	4 ± 0.1 (0.15)
Distance of Compartment to Sprocket Holes	F	7.5 ± 0.1 (0.295)
Distance of Compartment to Sprocket Holes	P ₂	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P ₁	12 ± 0.1 (0.472)



IR REFLOW SOLDERING TEMPERATURE PROFILE FOR SMD One Time Reflow Soldering is Recommended. Do not immerse device body in solder paste.



Profile Details	Conditions
Preheat - Min Temperature (T _{SMIN}) - Max Temperature (T _{SMAX}) - Time T _{SMIN} to T _{SMAX} (t _s)	150°C 200°C 60s - 120s
$\begin{tabular}{lll} \textbf{Soldering Zone} \\ - & \begin{tabular}{l} - $	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate (T _{smax} to T _P)	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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